

INDUSTRIAL STRENGTH... Start Your Application From YOURITECH

Integration support

Obsolescence Management

PCAP

Embedded Systems

Human Machine Interface

Touch Solutions

Software

Quality Management

Open Frame Monitors

LCD Controller

Research & Development

Firmware

EMC tests

on-site service

Optical Bonding

In-house Manufacturing

Cover glass

System solutions

OEM Solutions

Custom Display

Production Custom designs Installation

Mechanical design



Customer			
Keywords	5.5"TFT Display Module (480*960)		
Model	ET055BA01-TL		
Customer Approval		YOURITECH Approval	
SIGNATURE PREPARED BY	DATE	SIGNATURE PREPARED BY	DATE
_____	_____	_____	_____
REVIEWED BY		REVIEWED BY	
_____	_____	_____	_____
APPROVED BY (R&D)		APPROVED BY (R&D)	
_____	_____	_____	_____
APPROVED BY (QA)		APPROVED BY (QA)	
_____	_____	_____	_____



DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
V00	2023.3.11	New design	



1. Features & Mechanical specifications	1
2. Dimensional Outline	2
3. Block Diagram	3
4. Pin Description	4
5. Absolute Maximum Ratings	5
6. Electrical Characteristics	5
7. Backlight Specification	5
8. Electro-Optical Characteristics	6~7
9. Instruction Description	8
10. AC Characteristics	8
11. Quality Specification	9~17

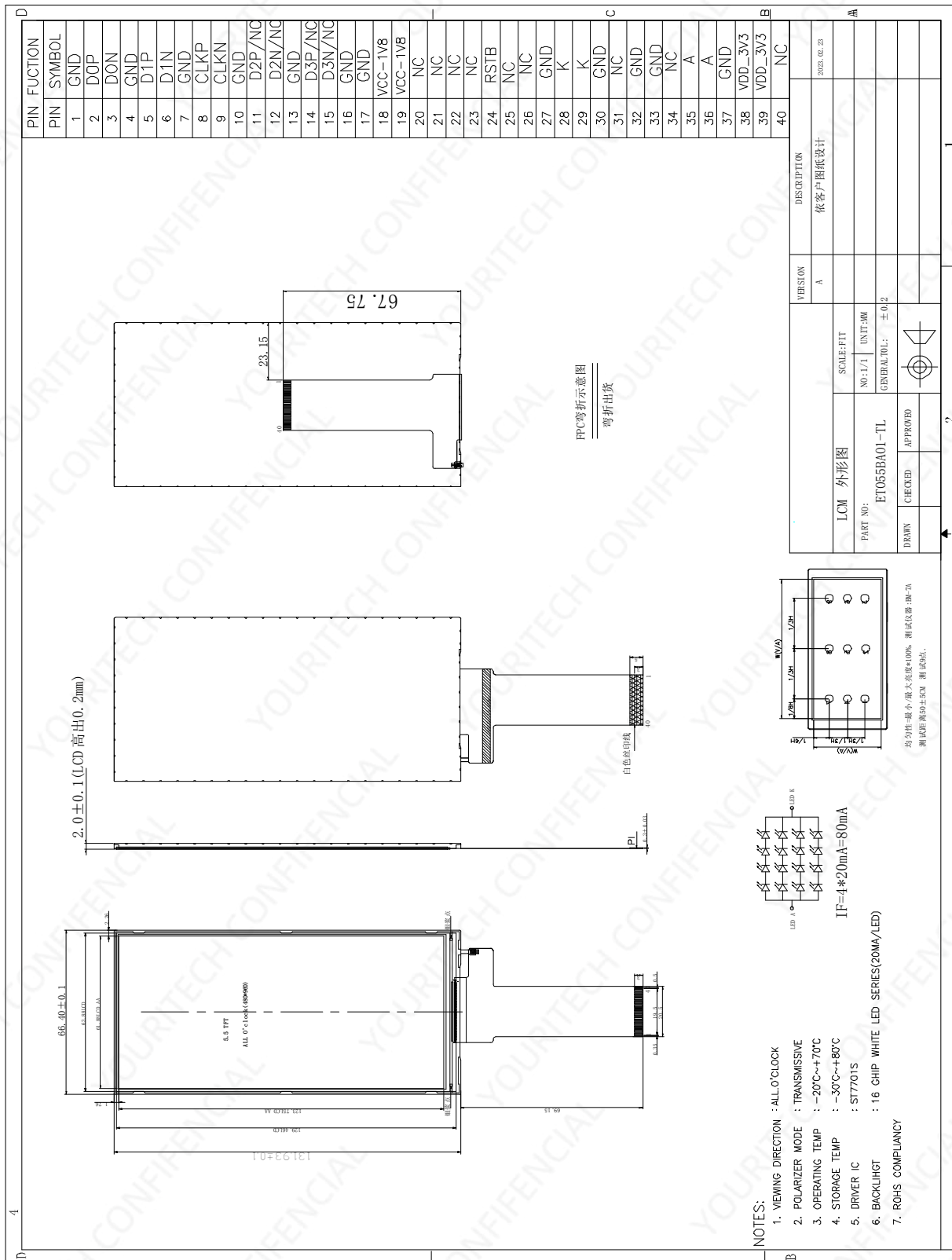


A. Features & Mechanical Specifications

Item	Contents	Unit
	LCD	
LCD Type	TFT Transmissive Normal Black	--
Viewing direction	ALL.O'CLOCK	--
Backlight	White LED x16in Parallel/ Series	--
Interface	MIPI 2LANES	--
Driver IC	ST7701S	--
Outline Dimension	66.40*131.93*2.15 MAX	mm
Glass area (W×H×T)	63.884 (H) x 129.458 (V) x 0.5 (T) (Typ.)	mm
Active area (W×H)	61.8768 (H) x 123.7536 (V)	mm
Number of Dots	480 RGB (H) x 960 (V)	pixels
Pixel pitch (W×H)	0.12891 (H) x 0.12891 (V)	mm
Operating Temperature	-20 ~ +70	℃
Storage temperature	-30 ~ +80	℃



B. Dimensional Outline



NOTES:

1. VIEWING DIRECTION : ALL 0°CLOCK
2. POLARIZER MODE : TRANSMISSIVE
3. OPERATING TEMP : -20°C~+70°C
4. STORAGE TEMP : -30°C~+80°C
5. DRIVER IC : ST7701S
6. BACKLIGHT : 16 CHIP WHITE LED SERIES(20MA)/LED
7. ROHS COMPLIANT



4. Pin Description

PIN No.	SYMBOL	Function
1	GND	Ground
2	DSI-D0P	DSI Data differential signal input pins. (Data lane0)
3	DSI-D0N	DSI Data differential signal input pins. (Data lane 0)
4	GND	Ground
5	DSI-D1P	DSI Data differential signal input pins. (Data lane 1)
6	DSI-D1N	DSI Data differential signal input pins. (Data lane 1)
7	GND	Ground
8	DSI-CLK P	DSI CLOCK differential signal input pins
9	DSI-CLK N	DSI CLOCK differential signal input pins
10	GND	Ground
11-12	NC	NC
13	GND	Ground
14-15	NC	NC
16-17	GND	Ground
18-19	IOVCC	I/O Power supply
20-23	NC	NC
24	RESET	Reset Signal pin ("Low" is enable)
25-26	NC	NC
27	GND	Ground
28-29	LEDK	Backlight LED Cathode
30	GND	Ground
31	NC	NC
32-33	GND	Ground
34	NC	NC
35-36	LEDA	Backlight LED Anode.
37	GND	Ground
38-39	VCC	Logic Power supply
40	NC	NC



5. Absolute Maximum Ratings

Item	Symbol	Rating			Unit
		MIN.	TYP.	MAX	
Operating Temperature range	TOP	-20	-	+70	°C
Storage Temperature range	TST	-30	-	+80	°C

6. Electrical Characteristics

DC Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Logic Supply Voltage	VCC	2.8	-	3.3	V
I/O Supply Voltage	IOVCC	1.8	-	3.3	V

注意：复位 RESET 电压必须与 IOVCC 保持一致，没有 IOVCC 时复位电压必须与 VCC 保持一致。

7. Backlight Characteristics

White LED × 16 in Parallel/ Series

(Ta = 25°C)

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	VF	IF=80mA	11.2	-	13.2	V
Uniformity	△Bp	-	80	-	-	%
Luminance for LCD	Lv	IF=80mA	650	730	-	cd/m ²



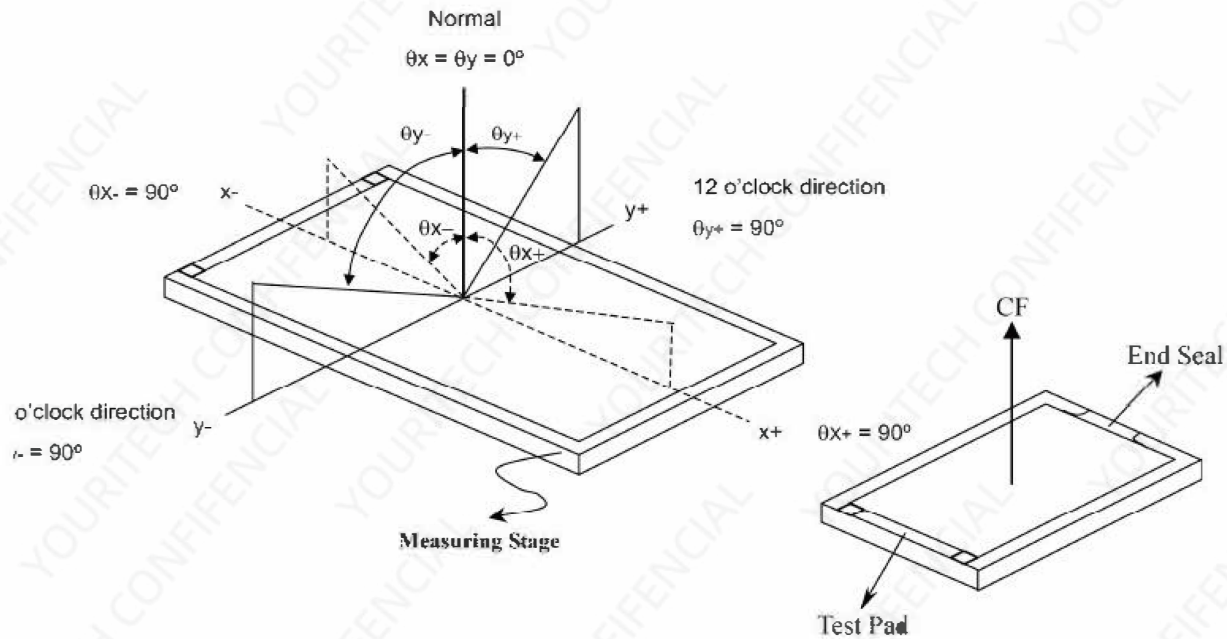
8. Electro-Optical Characteristics

Using LC+ Normal Polarizer+Corresponding Backlight, reference only (Note 1,Note 2)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Viewing Angle range	Horizontal	Θ_3	CR > 10	-	80	-	Deg.	Note 1
		Θ_9		-	80	-	Deg.	
	Vertical	Θ_{12}		-	80	-	Deg.	
		Θ_6		-	80	-	Deg.	
Contrast ratio		CR	$\Theta = 0^\circ$	-	800	-		Note 2
Transmittance		Tr		-	4.5	-	%	Base on C Light Note 3
White Chromaticity		x_w		-	0.298	-		Note 4 CF Glass Base on C Light
		y_w		-	0.328	-		
Reproduction of color (C light)	Red	R_x		-	0.659	-		
		R_y		-	0.322	-		
	Green	G_x		-	0.290	-		
		G_y		-	0.588	-		
	Blue	B_x		-	0.134	-		
		B_y		-	0.124	-		
Response Time (Rising + Falling)		$T_r + T_f$	Ta= 25° C $\Theta = 0^\circ$	-	30	35	ms	Note 5



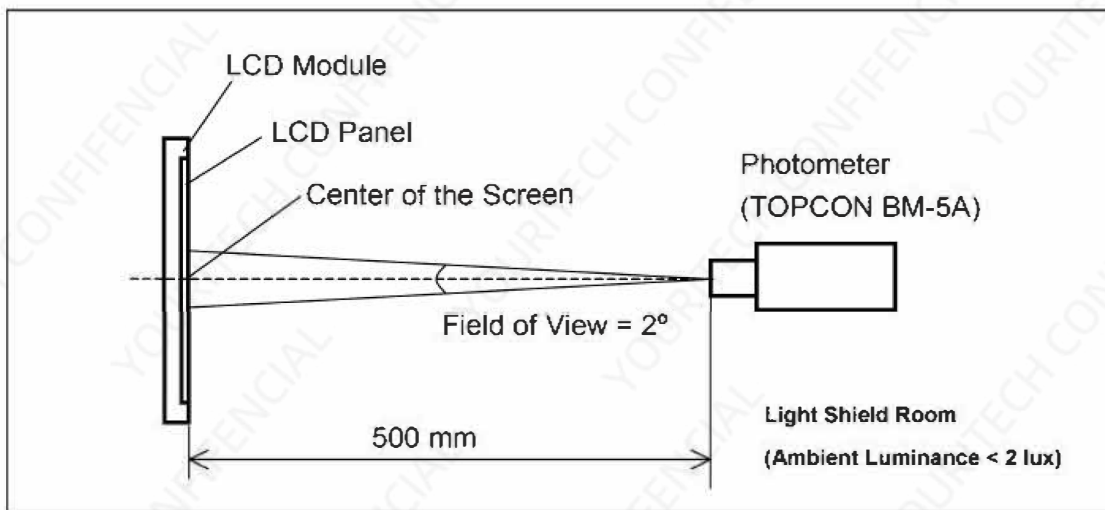
***Note(3) Definition of Viewing Angle**



*** The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

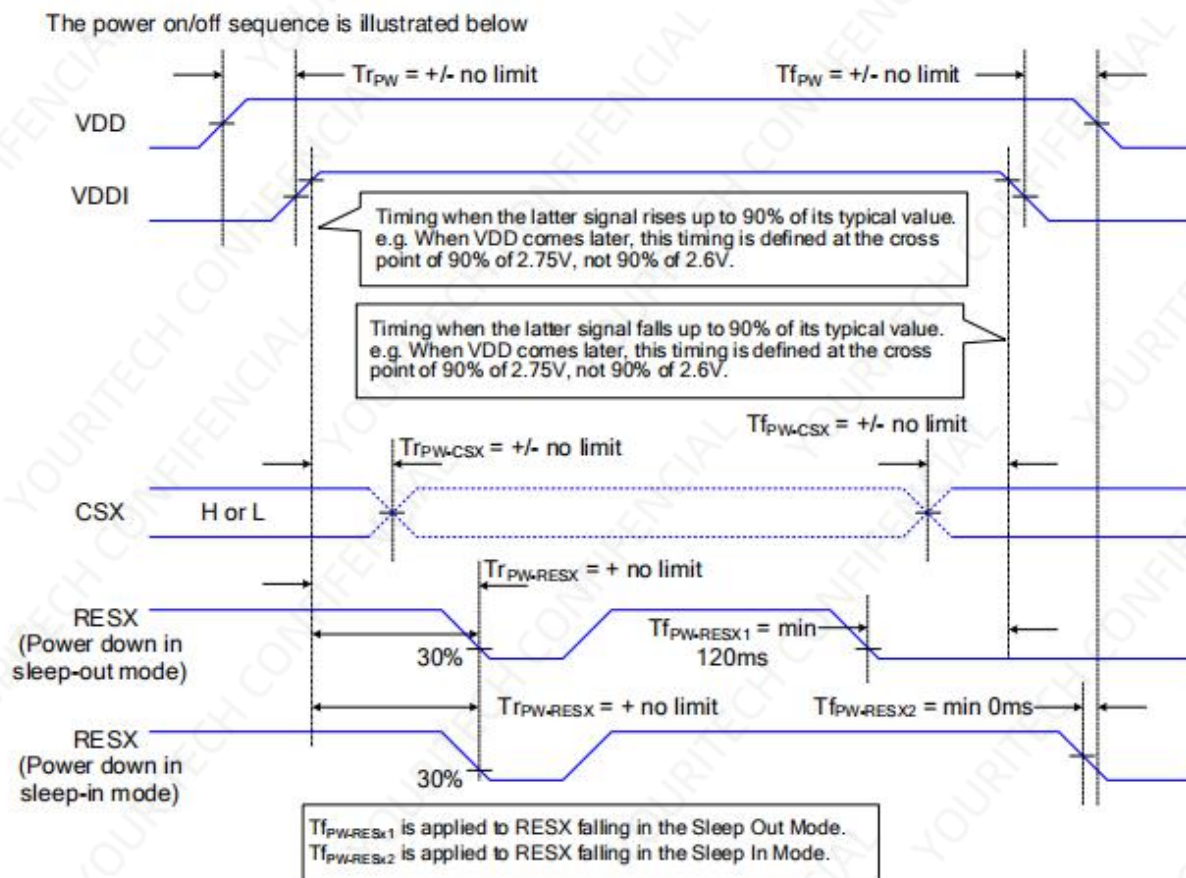
***Note (4) Measurement Set-Up:**

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



9. Instruction Description

Please refer to **ST7701S**



VDDI and VDDA can be applied or powered down in any order. During the Power Off sequence, if the LCD is in the Sleep Out mode, VDDA and VDDI must be powered down with minimum 120msec. If the LCD is in the Sleep In mode, VDDA and VDDI can be powered down with minimum 0msec after the RESX is released.

CSX can be applied at any timing or can be permanently grounded. RESX has high priority over CSX.

Notes:

- There will be no damage to the ST7701S if the power sequences are not met.
- There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.
- There will be no abnormal visible effects on the display between the end of Power On Sequence and before receiving the Sleep Out command, and also between receiving the Sleep In command and the Power Off Sequence.
- If the RESX line is not steadily held by the host during the Power On Sequence as defined in Sections 9.1 and 9.2, then it will be necessary to apply the Hardware Reset (RESX) after the completion of the Host Power On Sequence to ensure correct operations. Otherwise, all the functions are not guaranteed.

The power on/off sequence is illustrated below

The uncontrolled power-off means a situation which removed a battery without the controlled power off sequence. It will neither damage the module or the host interface.

If uncontrolled power-off happened, the display will go blank and there will not any visible effect on the display (blank display) and remains blank until "Power On Sequence" powers it up.



10. AC Characteristics

MIPI DSI Timing Characteristics HIGH SPEED MODE

7.5.4 MIPI Interface Characteristics:

7.5.4.1 High Speed Mode



Figure 4 DSI clock channel timing

Figure 5 Rising and falling time on clock and data channel

VDDI=1.8, VDD=2.8, AGND=DGND=0V, Ta=25 °C

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-CLK+/-	$2xUI_{INSTA}$	Double UI instantaneous	4	25	ns	
DSI-CLK+/-	UI_{INSTA} UI_{INSTB}	UI instantaneous halves	2	12.5	ns	$UI = UI_{INSTA} = UI_{INSTB}$
DSI-Dn+/-	t_{DS}	Data to clock setup time	0.15	-	UI	
DSI-Dn+/-	t_{DH}	Data to clock hold time	0.15	-	UI	

Table 7 Mipi Interface- High Speed Mode Timing Characteristics



11.Quality Specifications

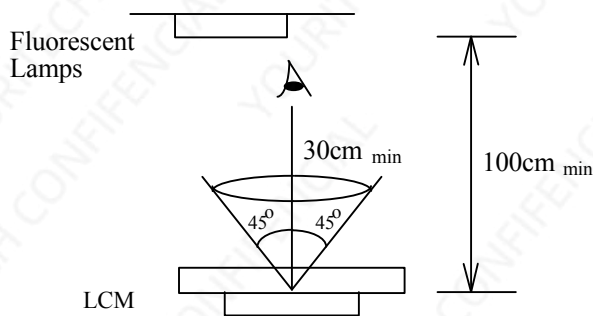
All The raw material are Rohs complicant.

11.1 Standard of the product appearance test

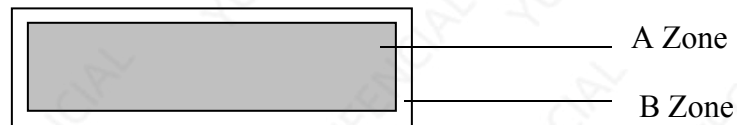
Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps.

Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area

B Zone: outside viewing area



11.2 Specification of quality assurance

AQL inspection standard

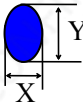
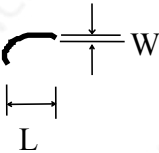
Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify	Item		Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	



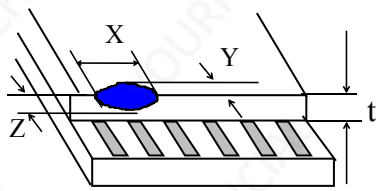
Note on defect classification

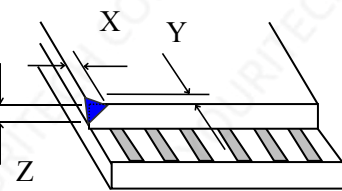
No.	Item	Criterion																				
1	Short or open circuit	Not allow																				
	LC leakage																					
	Flickering																					
	No display																					
	Wrong viewing direction																					
	Wrong Back-light																					
2	Contrast defect	Refer to approval sample																				
	Background color deviation																					
3	Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$	 <table><tr><th>Point Size</th><th>Acceptable Qty.</th></tr><tr><td>$\phi \leq 0.10$</td><td>Disregard</td></tr><tr><td>$0.10 < \phi \leq 0.20$</td><td>2（距离大于 5mm）</td></tr><tr><td>$0.20 < \phi \leq 0.25$</td><td>1</td></tr><tr><td>$\phi > 0.25$</td><td>0</td></tr></table> Unit: mm	Point Size	Acceptable Qty.	$\phi \leq 0.10$	Disregard	$0.10 < \phi \leq 0.20$	2（距离大于 5mm）	$0.20 < \phi \leq 0.25$	1	$\phi > 0.25$	0										
	Point Size	Acceptable Qty.																				
$\phi \leq 0.10$	Disregard																					
$0.10 < \phi \leq 0.20$	2（距离大于 5mm）																					
$0.20 < \phi \leq 0.25$	1																					
$\phi > 0.25$	0																					
4	Line defect, Scratch	 <table><tr><th colspan="2">Line</th><th>Acceptable Qty.</th></tr><tr><th>L</th><th>W</th><th></th></tr><tr><td>---</td><td>$0.015 \geq W$</td><td>Disregard</td></tr><tr><td>$3.0 \geq L$</td><td>$0.03 \geq W$</td><td rowspan="2">2</td></tr><tr><td>$2.0 \geq L$</td><td>$0.05 \geq W$</td></tr><tr><td>$1.0 \geq L$</td><td>$0.1 > W$</td><td>1</td></tr><tr><td>---</td><td>$0.05 < W$</td><td>Applied as point defect</td></tr></table> Unit: mm	Line		Acceptable Qty.	L	W		---	$0.015 \geq W$	Disregard	$3.0 \geq L$	$0.03 \geq W$	2	$2.0 \geq L$	$0.05 \geq W$	$1.0 \geq L$	$0.1 > W$	1	---	$0.05 < W$	Applied as point defect
Line		Acceptable Qty.																				
L	W																					
---	$0.015 \geq W$	Disregard																				
$3.0 \geq L$	$0.03 \geq W$	2																				
$2.0 \geq L$	$0.05 \geq W$																					
$1.0 \geq L$	$0.1 > W$	1																				
---	$0.05 < W$	Applied as point defect																				
5	Rainbow	Not more than two color changes across the viewing area.																				

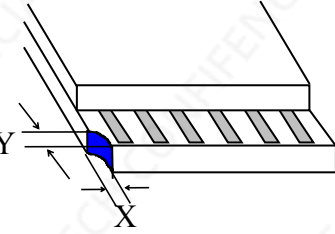
No	Item	Criterion
----	------	-----------

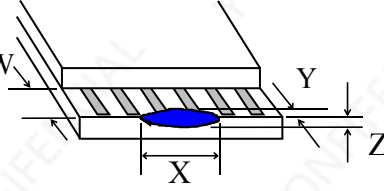


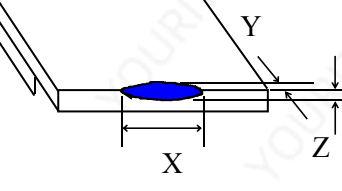
6	Chip	
Remark:		
X: Length direction		
Y: Short direction		
Z: Thickness direction		
t: Glass thickness		
W: Terminal Width		

	Acceptable criterion						
	<table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≤2</td><td>0.5mm</td><td>≤t/2</td></tr></table>	X	Y	Z	≤2	0.5mm	≤t/2
X	Y	Z					
≤2	0.5mm	≤t/2					

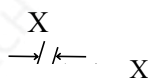
	Acceptable criterion						
	<table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≤2</td><td>0.5mm</td><td>≤t</td></tr></table>	X	Y	Z	≤2	0.5mm	≤t
X	Y	Z					
≤2	0.5mm	≤t					

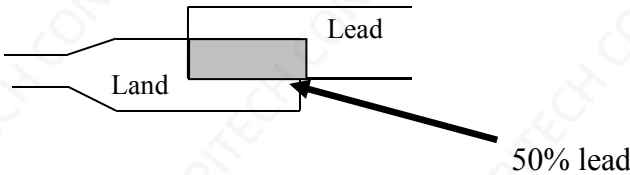
	Acceptable criterion								
	<table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≤3</td><td>≤2</td><td rowspan="2">≤t</td></tr><tr><td colspan="2">shall not reach to ITO</td></tr></table>	X	Y	Z	≤3	≤2	≤t	shall not reach to ITO	
X	Y	Z							
≤3	≤2	≤t							
shall not reach to ITO									

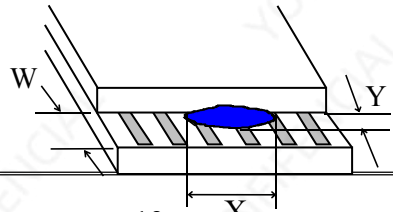
	Acceptable criterion						
	<table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>Disregard</td><td>≤0.2</td><td>≤t</td></tr></table>	X	Y	Z	Disregard	≤0.2	≤t
X	Y	Z					
Disregard	≤0.2	≤t					

	Acceptable criterion						
	<table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≤5</td><td>≤2</td><td>≤t/3</td></tr></table>	X	Y	Z	≤5	≤2	≤t/3
X	Y	Z					
≤5	≤2	≤t/3					

No.	Item	Criterion
7	Segment	(1) Pin hole

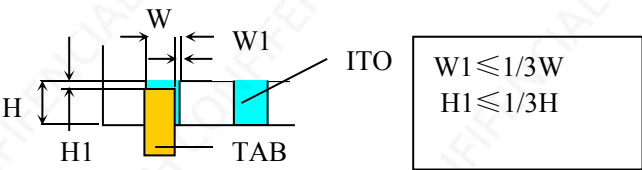
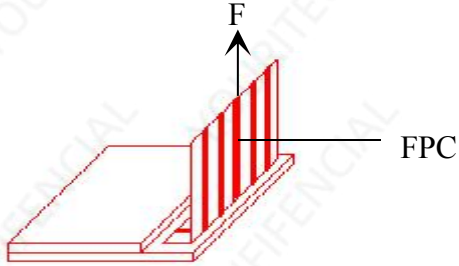


	pattern W = Segment width $\phi = (X+Y)/2$	$\phi < 0.10\text{mm}$ is acceptable.
8	Back-light	C. The color of backlight should correspond its specification. D. Not allow flickering
9	Soldering	E. Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) F. Over 50% of lead should be soldered on Land. 
10	Wire	G. Copper wire should not be rusted H. Not allow crack on copper wire connection. I. Not allow reversing the position of the flat cable. J. Not allow exposed copper wire inside the flat cable.
11*	PCB	K. Not allow screw rust or damage. L. Not allow missing or wrong putting of component.

No	Item	Criterion
12	Protruded W: Terminal Width	 Acceptable criteria: $Y \leq 0.4$

13



13	TAB	1. Position  2 FPC bonding strength test  $P (=F/\text{FPC bonding width}) \geq 650\text{gf/cm}$,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	M.Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.



11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	No abnormalities in functions and appearance
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	
Low temp. Operating	-20°C	48	
Humidity	60°C/ 90%RH	48	
Temp. Cycle	-30°C ← 25°C → 80°C (60 min ← 5 min → 60min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20±8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.



11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- N. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- O. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isopropyl alcohol, ethyl alcohol or trichlorotrifluoroethane, do not use water, ketone or aromatics and never scrub hard.
- P. Do not tamper in any way with the tabs on the metal frame.
- Q. Do not make any modification on the PCB without consulting SUNYEE.
- R. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- S. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- T. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- U. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- V. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- W. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- X. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- Y. Only properly grounded soldering irons should be used.
- Z. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- AA. The normal static prevention measures should be observed for work clothes and working benches.
- AB. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.



Soldering Precautions:

- AC. Soldering should be performed only on the I/O terminals.
- AD. Use soldering irons with proper grounding and no leakage.
- AE. Soldering temperature: $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- AF. Soldering time: 3 to 4 second.
- AG. Use eutectic solder with resin flux filling.
- AH. If flux is used, the LCD surface should be protected to avoid spattering flux.
- AI. Flux residue should be removed.

Operation Precautions:

- AJ. The viewing angle can be adjusted by varying the LCD driving voltage V_o .
 - AK. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
 - AL. Driving voltage should be kept within specified range; excess voltage will shorten display life.
 - AM. Response time increases with decrease in temperature.
 - AN. Display color may be affected at temperatures above its operational range.
6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

SUNYEE LCDs and modules are not consumer products, but may be incorporated by SUNYEE's customers into consumer products or components thereof, SUNYEE does not warrant that its LCDs and components are fit for any such particular purpose.

- AO. The liability of SUNYEE is limited to repair or replacement on the terms set forth below. SUNYEE will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between SUNYEE and the customer, SUNYEE will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with SUNYEE general LCD inspection standard. (Copies available on request)
- AP. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- AQ. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.

